



Product Change Notice

Micron PCN: 31178
Date: 4/01/2014

Type of Change:	Manufacturing Process Change	
Title of Change:	Component Plating change for 576Mb RLDRAM 3 (F67R) components	
Description of Change:	Component plating on Micron's 50nm 576Mb RLDRAM 3 (F67R) parts will change to Ni/Au process.	
Reason for Change:	Optimization of Manufacturing Efficiency	
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Product Affected: All 576Mb F67R Components

Affected Micron Part Number		
MT44K32M18RB-125E:A	MT44K16M36RB-107:A	MT44K32M18RB-093E IT:A
MT44K32M18RB-125F:A	MT44K16M36RB-107E:A	MT44K32M18RB-093E:A
MT44K32M18RB-107E:A	MT44K16M36RB-093 IT:A	MT44K16M36RB-125E:A
MT44K32M18RB-125:A	MT44K16M36RB-093:A	MT44K16M36RB-125F:A
MT44K32M18RB-125E IT:A	MT44K16M36RB-093E IT:A	MT44K32M18RB-093 IT:A
MT44K32M18RB-107:A	MT44K16M36RB-125:A	
MT44K16M36RB-093E:A	MT44K32M18RB-093:A	

Micron Sites Affected:	Micron Manassas (MTV),Micron Singapore(Tech)
Sample Available:	Now
Qual Data Available:	Now
Product Ship Date:	April 2014